

08-18-08

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Docket No. 55220/844

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Shoji Miyazaki et al.

Appl. No. : 10/809,217

Filed : March 25, 2004

For : BIOSENSOR, THIN FILM ELECTRODE FORMING METHOD,
QUANTIFICATION APPARATUS, AND QUANTIFICATION
METHOD

Customer No. : 1912

Examiner : Alexander Stephan Noguera

Art Unit : 1795

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT
PURSUANT to 37 C.F.R. §1.97(b)(3)

Mail Stop Amendment
 Commissioner for Patents
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Sir:

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I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail" service under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
Name:	Jeffrey C. Shindler
Signature:	[Handwritten Signature]

This Information Disclosure Statement is being filed to supplement the Information Disclosure Statements filed on March 25, 2004 and April 16, 2007 in connection with the above-identified application.

In accordance with the duty of disclosure under 37 C.F.R. §1.56, applicants would like to direct the Examiner's attention to the references that are listed on Form PTO/SB/08A (2 pages) and attached hereto.

Applicants note that the submitted references are references cited in Office

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Actions issued in connection with Japanese priority applications. In connection with Japanese Patent Application No 3-75552, applicants enclose a concise statement of relevancy. In connection with PCT Publication No. WO99/05516, applicants refer the Examiner to corresponding U.S. patent family member, U.S. Patent No. 6,599,406. In connection with Japanese Patent Application Publication Nos. 2-128153 and 2-1535, applicants enclose a copy of the corresponding European patent family member, EP 0311377 A2 and A3. In connection with Japanese Patent Application Publication No. 8-320304, applicants note that the corresponding family member, U.S. Patent No. 5,582,697, was previously disclosed in the April 16, 2007 Information Disclosure Statement.

Applicants are submitting this Information Disclosure Statement pursuant to 37 C.F.R. §1.97(b)(3) before the mailing of a first Office Action on the merits. Accordingly, no fee is deemed necessary in connection with the filing of this Information Disclosure Statement. However, if any fee is required in connection with the submission of this Information Disclosure Statement or to maintain the pendency of the subject application, authorization is hereby given to charge the amount of any such fee to Deposit Account No. 01-1785.

Respectfully submitted,

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Dated: August 15, 2008
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By


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